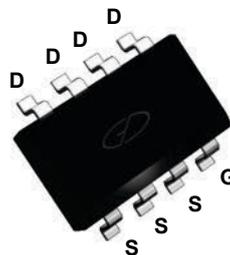
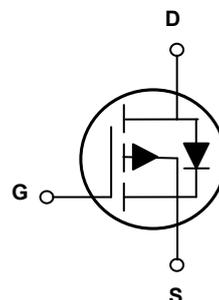


**Main Product Characteristics**

$BV_{DSS}$	-20V
$R_{DS(ON)}$	16m $\Omega$
$I_D$	-11A



SOP-8



Schematic Diagram

**Features and Benefits**

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



**Description**

The GSFQ2305 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

**Absolute Maximum Ratings** ( $T_C=25^{\circ}C$  unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Drain Current-Continuous ( $T_A=25^{\circ}C$ )	$I_D$	-11	A
Drain Current-Continuous ( $T_A=100^{\circ}C$ )		-7	
Drain Current-Pulsed <sup>1</sup>	$I_{DM}$	-44	A
Power Dissipation ( $T_A=25^{\circ}C$ )	$P_D$	2.5	W
Power Dissipation-Derate above 25 $^{\circ}C$		0.02	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	$^{\circ}C/W$
Operating Junction Temperature Range	$T_J$	-55 To +150	$^{\circ}C$
Storage Temperature Range	$T_{STG}$	-55 To +150	$^{\circ}C$

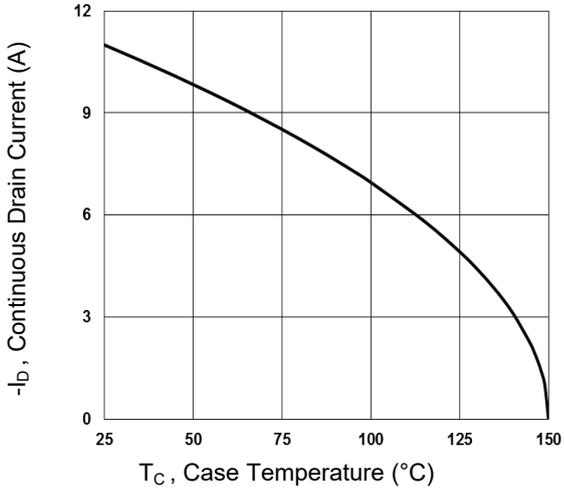
**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On/Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	-20	-	-	V
$BV_{DSS}$ Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^{\circ}\text{C}$ , $I_D=-1\text{mA}$	-	-0.01	-	$\text{V}/^{\circ}\text{C}$
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=-20V, V_{GS}=0V,$ $T_J=25^{\circ}\text{C}$	-	-	-1	$\mu\text{A}$
		$V_{DS}=-16V, V_{GS}=0V,$ $T_J=125^{\circ}\text{C}$	-	-	-10	$\mu\text{A}$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 10V, V_{DS}=0V$	-	-	$\pm 100$	nA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-6A$	-	10	12	m $\Omega$
		$V_{GS}=-4.5V, I_D=-6A$	-	12	16	
		$V_{GS}=-2.5V, I_D=-4A$	-	16	22	
		$V_{GS}=-1.8V, I_D=-3A$	-	21	28	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	-0.3	-0.6	-1.0	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		-	3	-	$\text{mV}/^{\circ}\text{C}$
Forward Transconductance	$g_{fs}$	$V_{DS}=-10V, I_D=-6A$	-	20	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>2,3</sup>	$Q_g$	$V_{DS}=-10V, I_D=-6A$ $V_{GS}=-4.5V$	-	27	40	nC
Gate-Source Charge <sup>2,3</sup>	$Q_{gs}$		-	2.4	4.8	
Gate-Drain Charge <sup>2,3</sup>	$Q_{gd}$		-	5.3	8	
Turn-On Delay Time <sup>2,3</sup>	$t_{d(on)}$	$V_{DD}=-10V, R_G=25\Omega$ $V_{GS}=-4.5V, I_D=-1A$	-	16.2	31	nS
Rise Time <sup>2,3</sup>	$t_r$		-	43.5	83	
Turn-Off Delay Time <sup>2,3</sup>	$t_{d(off)}$		-	114	217	
Fall Time <sup>2,3</sup>	$t_f$		-	28.8	55	
Input Capacitance	$C_{iss}$	$V_{DS}=-15V, V_{GS}=0V,$ $F=1\text{MHz}$	-	2320	3370	pF
Output Capacitance	$C_{oss}$		-	280	410	
Reverse Transfer Capacitance	$C_{rss}$		-	175	260	
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_S$	$V_G=V_D=0V,$	-	-	-11	A
Pulsed Source Current	$I_{SM}$	Force Current	-	-	-44	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=-1A,$ $T_J=25^{\circ}\text{C}$	-	-	-1	V

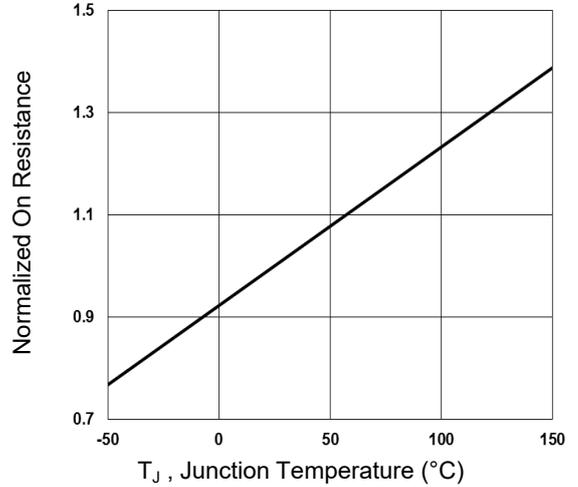
Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
3. Pulse test: pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

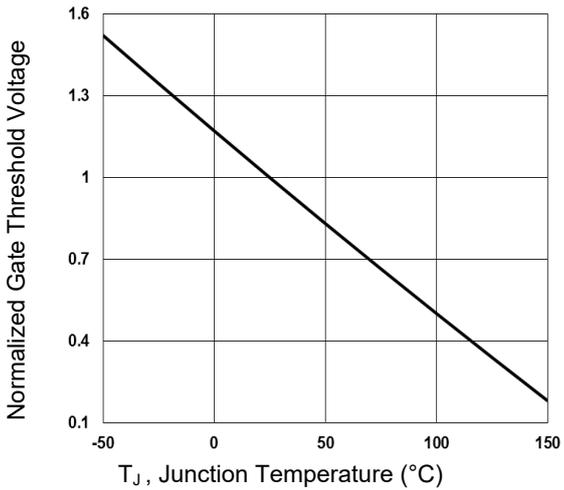
**Typical Electrical and Thermal Characteristic Curves**



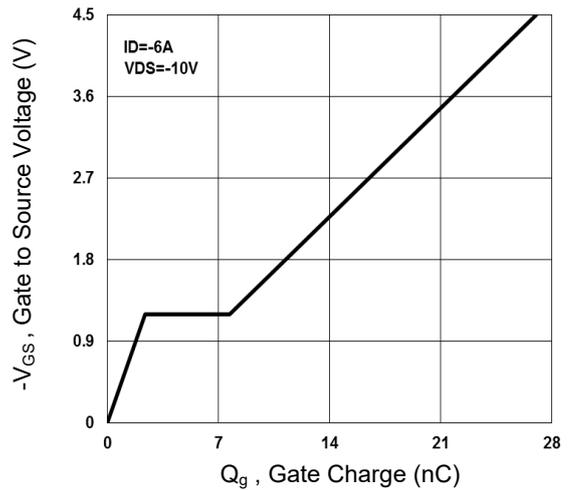
**Figure 1. Continuous Drain Current vs.  $T_c$**



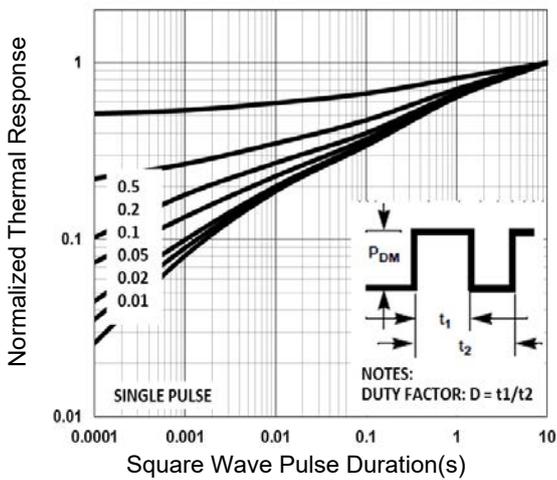
**Figure 2. Normalized  $R_{DSON}$  vs.  $T_j$**



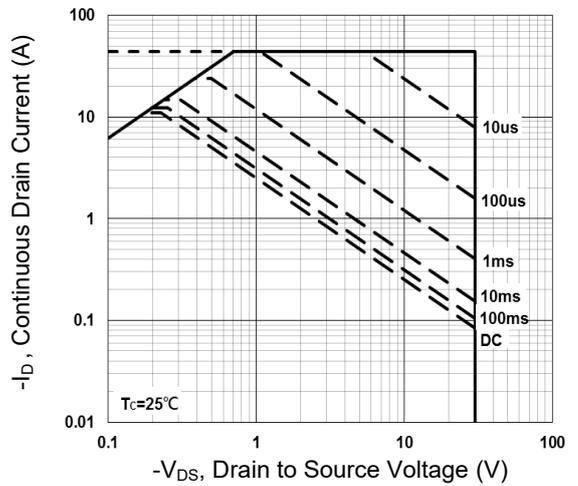
**Figure 3. Normalized  $V_{th}$  vs.  $T_j$**



**Figure 4. Gate Charge Waveform**

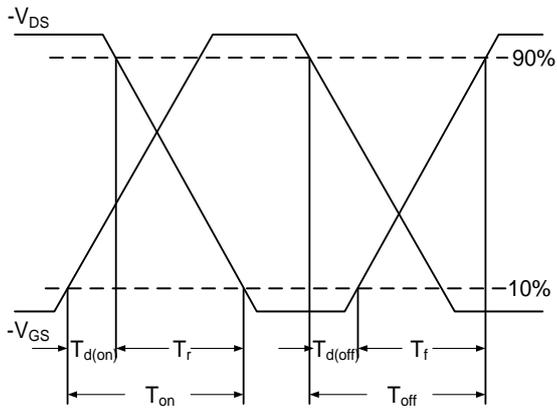


**Figure 5. Normalized Transient Response**

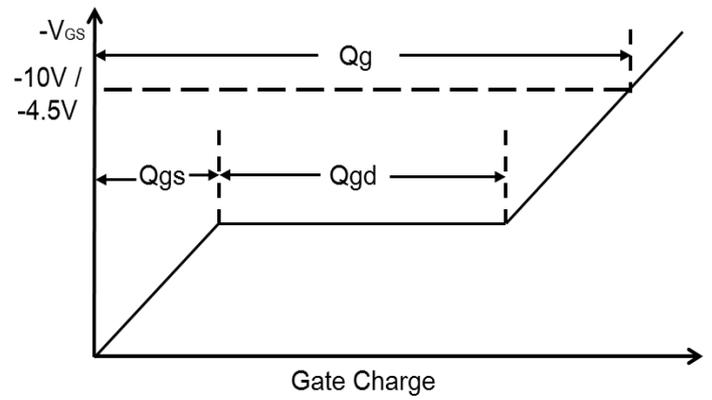


**Figure 6. Maximum Safe Operation Area**

**Typical Electrical and Thermal Characteristic Curves**



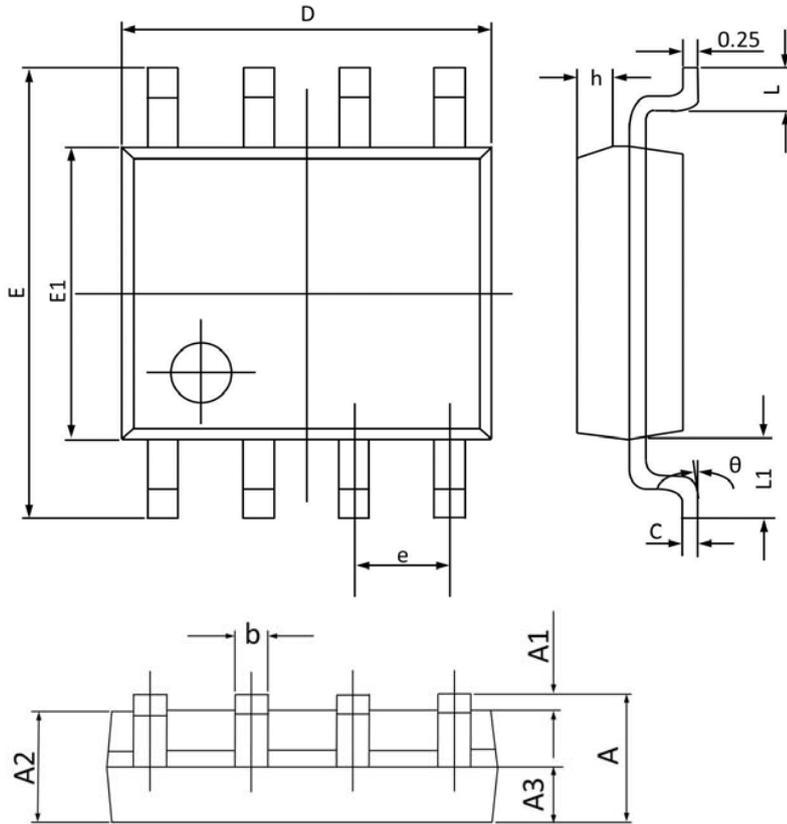
**Figure 7. Switching Time Waveform**



**Figure 8. Gate Charge Waveform**

**Package Outline Dimensions**

**SOP-8**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.800	0.053	0.069
A1	0.050	0.250	0.002	0.010
A2	1.250	1.650	0.049	0.065
A3	0.500	0.700	0.020	0.028
b	0.300	0.510	0.012	0.020
c	0.150	0.260	0.006	0.010
D	4.700	5.100	0.185	0.201
E	5.800	6.200	0.228	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.020
L	0.400	1.000	0.016	0.039
L1	1.050(BSC)		0.041(BSC)	
theta	0°	8°	0°	8°